

Attorney's Docket No.: 07402-039001

OFFICIAL COMMUNICATION

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FOR THE PERSONAL ATTENTION OF:

EXAMINER LOURDES CRUZ

GROUP 2815 FAX NO: (703) 872-9319

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Number of pages including this page 11

OCT 07 2002

TECHNOLOGY CENTER 2800

Applicant : Carlson, et al.

Art Unit : 2815

Serial No. : 09/547,061

Examiner : Lourdes Cruz

Filed : April 7, 2000

Confirmation No. : 3231

Title : INSULATOR/METAL BONDING ISLAND FOR ACTIVE AREA SILVER
EPOXY BONDING

FACSIMILE COMMUNICATION

Box AF

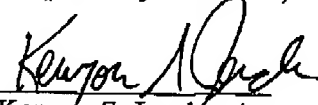
Commissioner for Patents
Washington, D.C. 20231

Sir:

Attached to this facsimile communication cover sheet is a Response and Notice of Appeal, faxed this 7th day of October, 2002, to Group 2815, the United States Patent and Trademark Office.

Respectfully submitted,

Date: October 7, 2002


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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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SILVER EPOXY BONDING

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RESPONSE

In response to the action mailed June 6, 2002, please amend
the application as follows:

In the claims:

Please cancel claims 14-17.

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Please amend claims 1, 5, and 9 as follows:

TECHNOLOGY CENTER 2800

-- 1. (Twice Amended) A semiconductor interconnection
system, comprising:

a semiconductor die;

first and second conductive contacts, said first
conductive contact coupled to a surface of said
semiconductor die, and said second conductive contact
coupled to an external structure;

a silver epoxy bond interposed between said first and
second conductive contacts, said epoxy bond providing

CERTIFICATE OF TRANSMISSION BY FACSIMILE

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Susan Regan

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